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GE Industrial Systems

**Functional Testing Specification**

*Renewal Services  
Louisville, KY*

**LOU-GED-193X255xx**

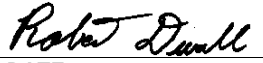
**Test Procedure for a Card**

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A	Initial release	D. Johnson	10/30/02
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## Functional test procedure for

### 1. SCOPE

1.1 This is a functional testing procedure for a.

### 2. STANDARDS OF QUALITY

2.1 Refer to the current revision of the IPC-A-610 standard for workmanship standards.

### 3. APPLICABLE DOCUMENTS

3.1 The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.

2.1.1

### 4. ENGINEERING REQUIREMENTS

#### 4.1 Equipment Cleaning

4.1.1 Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to the local documented procedures for cleaning guidelines.

#### 4.2 Equipment Inspection

4.2.1 Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:

4.2.1.1 Wires broken or cracked

4.2.1.2 Terminal strips / connectors broken or cracked

4.2.1.3 Loose wires

4.2.1.4 Components visually damaged

4.2.1.5 Capacitors leaking

4.2.1.6 Solder joints damaged or cold

4.2.1.7 Circuit board burned or de-laminated

4.2.1.8 Printed wire runs burned or damaged

### 5. EQUIPMENT REQUIRED

5.1 The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1		SCR Firing Box
1		Light Bulbs
1	H033531	Fixture
1		Oscilloscope
1		Power Supply(20vdc)

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## 6. TESTING PROCESS

### 6.1 Setup

- 6.1.1 Secure the card to the top of the fixture with the appropriate hardware
- 6.1.2 Plug the wires into the card from the fixture (HA and HB are not used)
- 6.1.3 On the Non-Isolated side of the SCR firing box connect the following:  
com(SCR) to com(fixture), positive(SCR) to + pulses(fixture)
- 6.1.4 Set the switches of the SCR firing box to off and normal
- 6.1.5 Connect two light bulbs in parallel into the appropriate jacks on the fixture
- 6.1.6 Plug the oscilloscope into the same jacks as the light bulbs
- 6.1.7 Connect power supply into the fixture (+ goes to 20vdc and – goes to com)

### 6.2 Testing Procedure

- 6.2.1 Plug 120vac into the fixture
- 6.2.2 Apply the 20vdc from the power supply
- 6.2.3 Turn on the oscilloscope
- 6.2.4 Switch the SCR firing box on
- 6.2.5 Turn the potentiometer and watch the waveform's signal increase; fully clockwise the waveform appears as figure 1.

### 6.3 \*\*\*TEST COMPLETE\*\*\*

## 7. NOTES